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AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the

application:

LISTING OF CLAIMS:

1. (currently amended): A magnetic head comprising a film comprised of diamond-

like carbon (hereinafter, referred to as "diamond-like carbon film") between a substrate and an

insulating layer, wherein said film has a Vickers hardness equal to or greater than 2000 kg/mm².

2. (canceled).

3. (original): The magnetic head according to claim 1, wherein said film has a

thickness equal to or greater than 100 nm.

4. (original): The magnetic head according to claim 1, wherein said magnetic head

is a magnetoresistive head.

5. (original): The magnetic head according to claim 4, wherein the diamond-like

carbon film, the insulating layer, a lower shield layer, a lower gap layer, a magnetoresistive

element, an upper gap layer, an upper shield layer, and a protective layer are provided in this

order on one side surface of the substrate.

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6. (original): The magnetic head according to claim 5, wherein said substrate is comprised of a nonmagnetic material.

- 7. (original): The magnetic head according to claim 6, wherein said nonmagnetic material is AlTiC (Al₂O₃ TiC), α -Fe₂O₃ (α -hematite), NiO-TiO₂-MgO, TiO₂-CaO, or NiO-MnO.
- 8. (original): The magnetic head according to claim 5, wherein said substrate is comprised of a magnetic material.
- 9. (original): The magnetic head according to claim 8, wherein said magnetic material is Ni-Zn ferrite or Mn-Zn ferrite.
- 10. (original): The magnetic head according to claim 5, wherein said magnetoresistive element is a magnetoresistive element comprising a lower layer in the form of a tantalum layer, a SAL bias layer in the form of a NiFeNb layer, an intermediate insulating layer in the form of a tantalum layer, a magnetoresistive layer in the form of a NiFe layer, and an upper layer in the form of a tantalum layer in this order.
- 11. (original): The magnetic head according to claim 5, wherein said substrate has a thickness ranging from 60 to 100 μm .

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12. (original): The magnetic head according to claim 5, wherein said insulating layer has a thickness ranging from 15 to 30 μm .

- 13. (original): The magnetic head according to claim 5, wherein said lower shield layer has a thickness ranging from 2 to 4 μm .
- 14. (original): The magnetic head according to claim 5, wherein said upper shield layer has a thickness ranging from 2 to 4 μm .
- 15. (original): The magnetic head according to claim 5, wherein said lower gap layer has a thickness ranging from 60 to 140 nm.
- 16. (original): The magnetic head according to claim 5, wherein said upper gap layer has a thickness ranging from 80 to 160 nm.
- 17. (original): The magnetic head according to claim 5, wherein said protective layer has a thickness ranging from 2 to 6 μ m.
 - 18. (original): The magnetic head according to claim 4, wherein the substrate is comprised of a nonmagnetic material, and

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the diamond-like carbon film, the insulating layer comprised of an insulating material, a lower shield layer comprised of a magnetic material, a lower gap layer comprised of a nonmagnetic material, a magnetoresistive element, an upper gap layer comprised of a nonmagnetic material, an upper shield layer comprised of a magnetic material, and a protective layer comprised of an insulating material are provided in this order on one side surface of the substrate.

- 19. (original): The magnetic head according to claim 18, wherein said substrate is comprised of AlTiC (Al₂O₃ TiC), α -Fe₂O₃ (α -hematite), NiO-TiO₂-MgO, TiO₂-CaO, or NiO-MnO.
- 20. (original): The magnetic head according to claim 18, wherein said insulating layer is comprised of alumina (Al₂O₃), silica (SiO₂), AlN, Al-N-X (where X denotes one or more of Si, B, Cr, Ti, Ta and Nb), SiN, SiC, DLC, BN, MgO, SiAlON, AlON, Si₃Na, SiCO, SiON, or SiCON.
- 21. (original): The magnetic head according to claim 18, wherein said lower shield layer and said upper lower shield layer are respectively comprised of Fe-Si-Al alloy (Sendust), Ni-Fe alloy (Permalloy), or Ni-Zn alloy (hematite).

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22. (original): The magnetic head according to claim 18, wherein said lower gap layer and said upper gap layer are respectively comprised of alumina (Al₂O₃) or silica (SiO₂).

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- 23. (original): The magnetic head according to claim 18, wherein said magnetoresistive element is a magnetoresistive element comprising a lower layer in the form of a tantalum layer, a SAL bias layer in the form of a NiFeNb layer, an intermediate insulating layer in the form of a tantalum layer, a magnetoresistive layer in the form of a NiFe layer, and an upper layer in the form of a tantalum layer in this order.
- 24. (original): The magnetic head according to claim 18, wherein said protective layer is comprised of alumina (Al₂O₃) or silica (SiO₂).
- 25. (original): The magnetic head according to claim 18, wherein said substrate has a thickness ranging from 60 to 100 $\,\mu$ m.
- 26. (original): The magnetic head according to claim 18, wherein said insulating layer has a thickness ranging from 15 to 30 μ m.
- 27. (original): The magnetic head according to claim 18, wherein said lower shield layer has a thickness ranging from 2 to 4 μ m.

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28. (original): The magnetic head according to claim 18, wherein said upper shield layer has a thickness ranging from 2 to 4 μ m.

- 29. (original): The magnetic head according to claim 18, wherein said lower gap layer has a thickness ranging from 60 to 140 nm.
- 30. (original): The magnetic head according to claim 18, wherein said upper gap layer has a thickness ranging from 80 to 160 nm.
- 31. (original): The magnetic head according to claim 18, wherein said protective layer has a thickness ranging from 2 to 6 μ m.